



## IN THE U.S. PATENT AND TRADEMARK OFFICE

August 11, 1994

Applicant(s): Iver E. ANDERSON, et al

: Pb-FREE Sn-Ag-Cu TERNARY EUTECTIC SOLDER For

Serial No. : 08/094 854 : 3205 Group

: July 20, 1993 Examiner: Knapp Filed

The Commissioner of Patents and Trademarks Washington, D. C. 20231

PETITION FOR TIME EXTENSION, AND CERTIFICATE OF MAILING

Sir:

A Response is enclosed.

Pursuant to 37 CFR 1.136(a), please extend the shortened period for response by two months. The extension fee is:

[ ] \$ 360.00 (37 CFR 1.17b)

\$ 180.00 (37 CFR 1.17b; small entity status established by verified statement(s) submitted previously).

A check for \$ 291.00 is enclosed to cover fees.

If this Petition is not timely received, please extend the shortened period an additional month. Please credit any overpayment, or charge any additional fee required by this Petition, to Deposit Account No. 06-1382. A duplicate of this Petition is enclosed.

IN DUPLICATE

EJT/qc

FLYNN, THIEL, BOUTELL & TANIS, P.C.

2026 Rambling Road Kalamazoo, MI 49008-1699

Phone: (616) 381-1156

Fax : (616) 381-5465

Respectfully submitted,

Dale H. Thiel

David G. Boutell

Ronald J. Tanis

T. Murray Smith

Terryence F. Chapman Edward J. Timmer

Reg.No. 22 724

Reg.No. 30 222 Reg.No. 32 549

Reg.No. 24 323 Reg.No. 25 072

Reg.No. 27 402

Caroline M. Koestner Req.No. 36 329

Encl: Check

Response dated August 11, 1994

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C.

20231, on <u>August 11, 1994</u>.

080 WC 08/25/94 08094854 180.8905